## 504790693 02/23/2018

# PATENT ASSIGNMENT COVER SHEET

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 SUBMISSION TYPE:
 NEW ASSIGNMENT

 NATURE OF CONVEYANCE:
 ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
WEN-SHIANG LIAO	01/25/2018
CHIH-HANG TUNG	02/02/2018
CHEN-HUA YU	02/08/2018
CHEWN-PU JOU	01/12/2018
FENG WEI KUO	02/02/2018

#### **RECEIVING PARTY DATA**

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING COMPANY LIMITED
Street Address:	NO. 8, LI-HSIN RD. VI, HSINCHU SCIENCE PARK
City:	HSINCHU
State/Country:	TAIWAN

#### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	15897272

### **CORRESPONDENCE DATA**

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Address Line 4: NEW YORK, NEW YORK 10281-1047

ATTORNEY DOCKET NUMBER: 181877-625354

NAME OF SUBMITTER: MATTHEW W. JOHNSON

SIGNATURE: //Matthew W. Johnson/

DATE SIGNED: 02/23/2018

**Total Attachments: 2** 

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PATENT 504790693 REEL: 045431 FRAME: 0013



#### ASSIGNMENT

WHEREAS, WE, Wen-Shiang Liao, having a mailing address of No. 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu, Taiwan residing at Miaoli County, Taiwan, Chih-Hang Tung, having a mailing address of No. 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu, Taiwan residing at Hsinchu, Taiwan, CHEN-HUA YU, having a mailing address of No. 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu, Taiwan residing at Hsinchu city, Taiwan, Chewn-Pu Jou, having a mailing address of No. 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu, Taiwan residing at Hsinchu, Taiwan and Feng Wei Kuo, having the mailing address of No. 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu, Taiwan residing at Hsinchu County, Taiwan, ASSIGNORS, are the inventors of the invention in "INTEGRATED FAN-OUT PACKAGE WITH 3D MAGNETIC CORE INDUCTOR" for which we have executed an application for a Patent of the United States

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M	3 which is identified by Jones Day docket no. 11	31877-625354	
$\Box$	which was filed on, App	olication No	·································
	We hereby authorize and request afterney(s) a	at Jones Day, to inser	there in parentheses (Application number
	, filed	) the filing date and	d application number of said application when known.

and WHEREAS, Taiwan Semiconductor Manufacturing Company Limited, a corporation organized and existing under the laws of the Republic of China, and having an office for the transaction of business at No. 8, Li-Hsin Rd. VI, Hsinchu Science Park, Hsinchu, Taiwan, PROPRIETOR, is desirous of obtaining our entire right, title and interest in, to and under the said invention and the said application:

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, we, the said ASSIGNORS, have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said PROPRIETOR, its successors, legal representatives and assigns, our entire right, title and interest in, to and under the said invention, and the said United States application and all divisions, renewals and continuations thereof, and all Patents of the United States which may be granted thereon and all reissues and extensions thereof; and all applications for industrial property protection, including, without limitation, all applications for patents, utility models, and designs which may be filed for said invention in any country or countries foreign to the United States, together with the right to file such applications and the right to claim for the same the priority rights derived from said United States application under the Patent Laws of the United States, the International Convention for the Protection of Industrial Property, or any other international agreement or the domestic laws of the country in which any such application is filed, as may be applicable; and all forms of industrial property protection, including, without limitation, patents, utility models, inventors' certificates and designs which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof; and all right to sue for infringement including past infringement.

AND WE HEREBY authorize and request the Commissioner for Patents and any Official of any country or countries foreign to the United States, whose duty it is to issue patents or other evidence or forms of industrial property protection on applications as aforesaid, to issue the same to the said PROPRIETOR, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND WE HEREBY covenant and agree that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to the said PROPRIETOR, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing, reissue and foreign applications, make all rightful oaths, and generally do everything possible to aid the said PROPRIETOR, its successors, legal representatives and assigns, to obtain and enforce proper protection for said invention in all countries.

REEL: 045431 FRAME: 0014

IN TESTIMONY WHEREOF, We hereunto set our hands and seals the day and year set opposite our respective signatures.

Date _	Jan. 25,20/8	Wen-Shiang Liao France	L.S
Date _	Feb 2 , 2018	Chih-Hang Tung	L.S
Date _	2/5/1/8	CHEN-HVA YU	L.S
Date _	2018/02/12	Chewn-Pu Jou	L.S
Date _	20(8,02,02	Feng Wet Kur	L.S.

RECORDED: 02/23/2018 REEL: 045431 FRAME: 0015